FUJI ELECTRIC

2SK2446-L,S

F-III Series

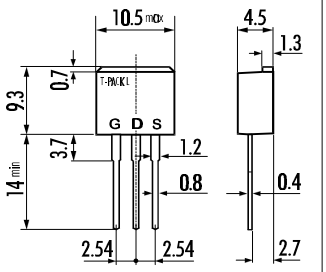
N-channel MOS-FET			
100V	0,055Ω	30A	80W

> Features

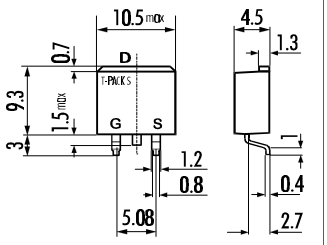
- High Current
- Low On-Resistance
- No Secondary Breakdown
- Low Driving Power
- High Forward Transconductance

> Outline Drawing

T-PACK L



T-PACK S



> Applications

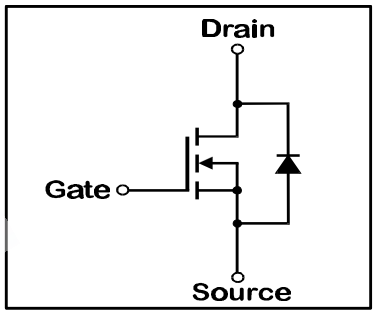
- Motor Control
- General Purpose Power Amplifier
- DC-DC converters

> Maximum Ratings and Characteristics

- Absolute Maximum Ratings (T_C=25°C), unless otherwise specified

Item	Symbol	Rating	Unit
Drain-Source-Voltage	V_{DS}	100	V
Drain-Gate-Voltage (R_{GS}=20KΩ)	V_{DGR}	100	V
Continous Drain Current	I_D	30	A
Pulsed Drain Current	$I_{D(puls)}$	120	A
Gate-Source-Voltage	V_{GS}	±20	V
Max. Power Dissipation	P_D	80	W
Operating and Storage Temperature Range	T_{ch}	150	°C
	T_{stg}	-55 ~ +150	°C

> Equivalent Circuit



- Electrical Characteristics (T_C=25°C), unless otherwise specified

Item	Symbol	Test conditions		Min.	Typ.	Max.	Unit
Drain-Source Breakdown-Voltage	$V_{(BR)DSS}$	I_D=1mA	V_{GS}=0V	100			V
Gate Threshhold Voltage	$V_{GS(th)}$	I_D=1mA	V_{DS}=V_{GS}	1,0	1,5	2,5	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=100V	T_{ch}=25°C		10	500	µA
		V_{GS}=0V	T_{ch}=125°C		0,2	1,0	mA
Gate Source Leakage Current	I_{GSS}	V_{GS}=±20V	V_{DS}=0V		10	100	nA
Drain Source On-State Resistance	$R_{DS(on)}$	I_D=15A	V_{GS}=4V		0,04	0,07	Ω
		I_D=15A	V_{GS}=10V		0,03	0,055	Ω
Forward Transconductance	g_{fs}	I_D=15A	V_{DS}=25V	15	30		S
Input Capacitance	C_{iss}	V_{DS}=25V			2500	3700	pF
Output Capacitance	C_{oss}	V_{GS}=0V			500	750	pF
Reverse Transfer Capacitance	C_{rss}	f=1MHz			250	380	pF
Turn-On-Time t_{on} (t_{on}=$t_{d(on)}$+t_r)	$t_{d(on)}$	V_{CC}=30V			20	30	ns
	t_r	I_D=30A			140	210	ns
Turn-Off-Time t_{off} (t_{on}=$t_{d(off)}$+t_f)	$t_{d(off)}$	V_{GS}=10V			500	750	ns
	t_f	R_{GS}=25Ω			260	390	ns
Diode Forward On-Voltage	V_{SD}	I_F=2xI_{DR}	V_{GS}=0V T_{ch}=25°C		0,9	1,5	V
Reverse Recovery Time	t_{rr}	I_F=I_{DR}	V_{GS}=0V		130		ns
Reverse Recovery Charge	Q_{rr}	-dI_F/dt=100A/µs	T_{ch}=25°C		1,0		µC

- Thermal Characteristics

	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Thermal Resistance	$R_{th(ch-a)}$	channel to air			125	°C/W
	$R_{th(ch-c)}$	channel to case			1,56	°C/W

N-channel MOS-FET			
100V	0,055Ω	30A	80W

2SK2446-L,S

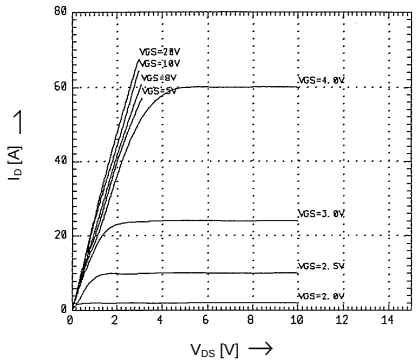
F-III Series

FUJI ELECTRIC

> Characteristics

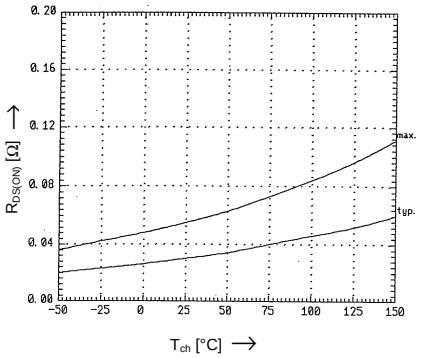
Typical Output Characteristics

$I_D=f(V_{DS})$; 80µs pulse test; $T_C=25°C$



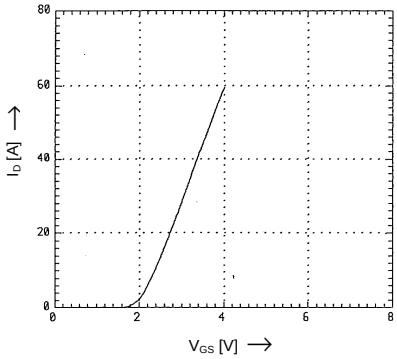
Drain-Source On-State Resistance vs. T_{ch}

$R_{DS(on)} = f(T_{ch})$; $I_D=15A$; $V_{GS}=10V$



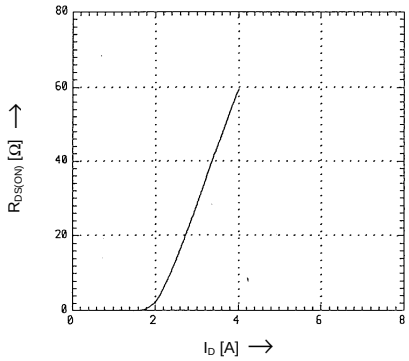
Typical Transfer Characteristics

$I_D=f(V_{GS})$; 80µs pulse test; $V_{DS}=25V$; $T_{ch}=25°C$



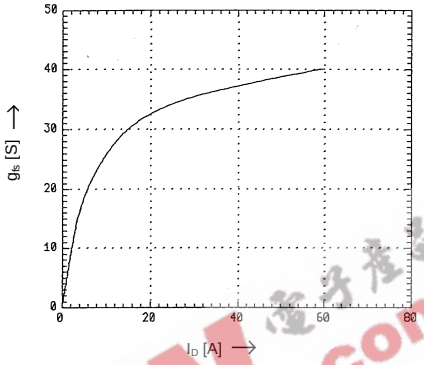
Typical Drain-Source On-State-Resistance vs. I_D

$R_{DS(on)}=f(I_D)$; 80µs pulse test; $T_C=25°C$



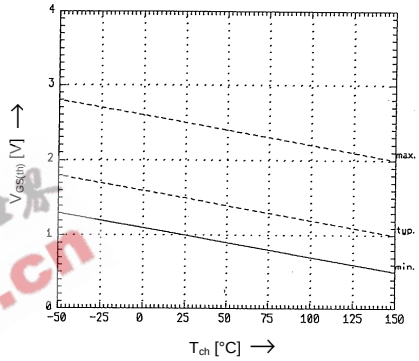
Typical Transconductance

$g_{fs}=f(I_D)$; 80µs pulse test; $V_{DS}=25V$; $T_{ch}=25°C$



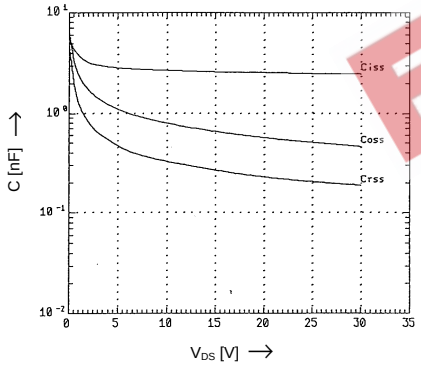
Gate Threshold Voltage

$V_{GS(th)}=f(T_{ch})$; $I_D=1mA$; $V_{DS}=V_{GS}$



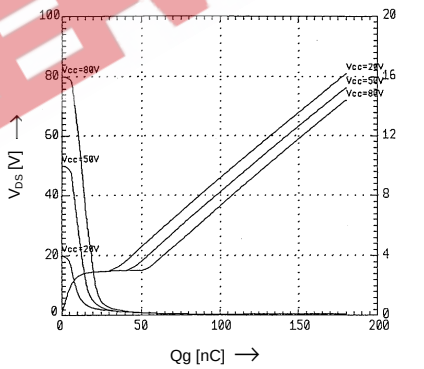
Typical Capacitances

$C=f(V_{DS})$; $V_{GS}=0V$; $f=1MHz$



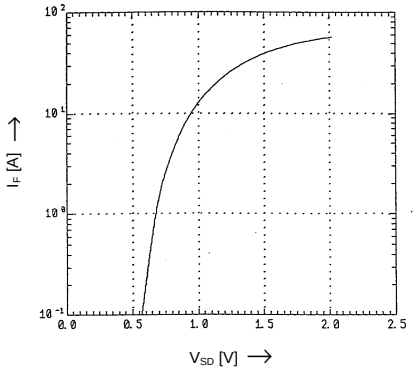
Typical Gate Charge Characteristic

$V_{GS}=f(Qg)$; $I_D=30A$



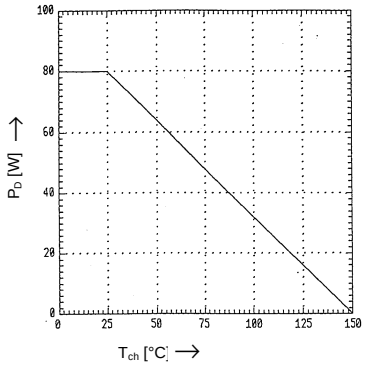
Forward Characteristics of Reverse Diode

$I_F=f(V_{SD})$; 80µs pulse test; $V_{GS}=0V$



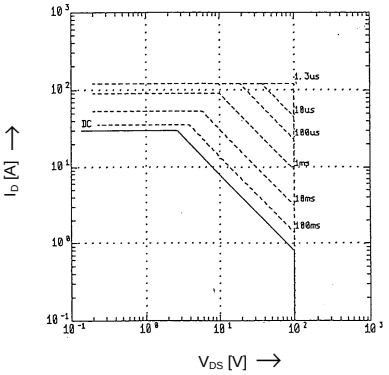
Power Dissipation

$P_D=f(Tc)$



Safe Operation Area

$I_D=f(V_{DS})$: D=0,01, Tc=25°C



Transient Thermal impedance

$Z_{th(ch-c)}=f(t)$ parameter:D=t/T